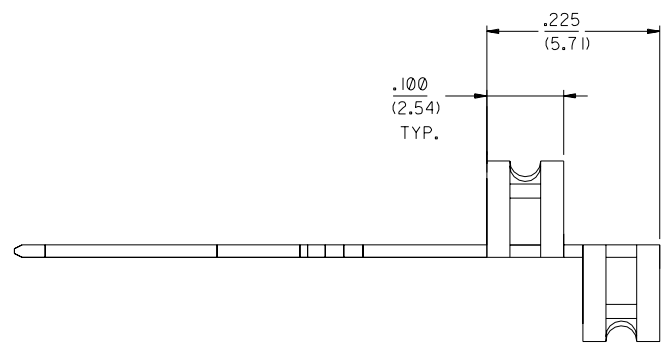


VIEWS SHOWN PRE-TERMINATED



- NOTES:
1. MATERIAL: COPPER ALLOY.
  2. PLATING - CONTACT AREA: 30 MICROINCHES/(0.76 MICROMETERS) MINIMUM GOLD OVER NICKEL UNDERPLATE OVERALL. OR GOLD FLASH OVER 40 MICROINCHES/(1.00 MICROMETERS) MINIMUM PALLADIUM-NICKEL OVER NICKEL UNDERPLATE OVERALL.
  3. PLATING -COAX BRAID AREA : 150 MICROINCHES/(3.81 MICROMETERS) MINIMUM TIN OVER NICKEL UNDERPLATE OVERALL.
  4. PARTS ARE SHIPPED ON REELS: QUANTITY TO BE 4,000 PARTS PER REEL
  5. REFER TO PS-71754-9999 FOR ASSEMBLY AND TERMINATION DETAILS.
  6. "X" IN STATUS COLUMN REFLECTS NOT TOOLED
- NOTE FOR LEAD FREE CONVERSION:  
THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH LEAD.

STATUS	ITEM PART NUMBERS AND PLATING	
A	71198-1001	30 MICROINCHES/(0.76 MICROMETERS) MINIMUM GOLD OVER NICKEL UNDERPLATE OVERALL IN CONTACT AREA 150 MICROINCHES MINIMUM TIN OVER NICKEL UNDERPLATE OVERALL IN COAX BRAID AREA.
X	71198-1002	GOLD FLASH OVER 40 MICROINCHES/(1.00 MICROMETERS) MINIMUM PALLADIUM-NICKEL OVER NICKEL UNDERPLATE OVERALL IN CONTACT AREA, 150 MICROINCHES MINIMUM TIN OVER NICKEL UNDERPLATE OVERALL IN COAX BRAID AREA.

DIMENSIONS SHOWN (METRIC) INCH UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR ± 1/2°		REVISE ONLY ON CAD SYSTEM	
3 PLACE ± .010	INCH	---	METRIC
2 PLACE ±	---	± 0.25	---
1 PLACE ---	±	---	---
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			
DRWG. BY: MOS	CHK'D. BY: PAM	FILE NAME: ST119851.DGN	DATE: 12/13/95
APP'D. BY: JWN	SCALE: 8:1	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.	

TITLE: GROUND PLANE FOR EVC CABLE ASSEMBLIES SALES DETAIL		SHEET NO. 1 OF 1	
PART NO. SEE CHART SD-71198-100*		DATE: 12/13/95	
MFG. SH. REV. LTR. REVISIONS		MOLEX INCORPORATED U.S.A.	